MRF5S19150R3 and MRF5S19150SR3 replaced by MRF5S19150HR3 and MRF5S19150HSR3. "H" suffix indicates lower thermal resistance package.

The RF MOSFET Line **RF Power Field Effect Transistors**

N-Channel Enhancement-Mode Lateral MOSFETs

Designed for PCN and PCS base station applications at frequencies from 1.9 to 2.0 GHz. Suitable for TDMA, CDMA and multicarrier amplifier applications.

Typical 2-Carrier N-CDMA Performance for $V_{DD}=28$ Volts, $P_{out}=32$ Watts, $I_{DQ}=1400$ mA, f1=1958.75 MHz, f2=1961.25 MHz IS-95 CDMA (Pilot, Sync, Paging, Traffic Codes 8 Through 13) 1.2288 MHz Channel Bandwidth Carrier. Adjacent Channels Measured over a 30 kHz Bandwidth at f1-885 kHz and f2+885 kHz. Distortion Products Measured over 1.2288 MHz Bandwidth at f1-2.5 MHz and f2+2.5 MHz. Peak/Avg. = 9.8 dB @ 0.01% Probability on CCDF.

Output Power — 32 Watts Avg.

Power Gain — 14 dB

Efficiency — 26%

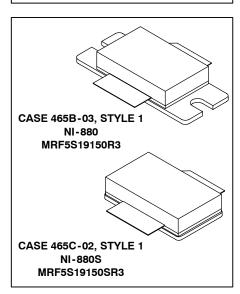
ACPR — -50 dB

IM3 - -36.5 dBc

- Internally Matched, Controlled Q, for Ease of Use
- High Gain, High Efficiency and High Linearity
- Integrated ESD Protection
- Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 5:1 VSWR, @ 28 Vdc, f1 = 1960 MHz, 100 Watts CW Output Power
- Excellent Thermal Stability
- Qualified Up to a Maximum of 32 V Operation
- In Tape and Reel. R3 Suffix = 250 Units per 56 mm, 13 inch Reel.

MRF5S19150R3 MRF5S19150SR3

1990 MHz, 32 W, 28 V LATERAL N-CHANNEL RF POWER MOSFETs



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	65	Vdc
Gate-Source Voltage	V _{GS}	-0.5, +15	Vdc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	357 2	Watts W/°C
Storage Temperature Range	T _{stg}	- 65 to +150	°C
Operating Junction Temperature	T _J	200	°C
CW Operation	CW	100	Watts

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value (1,2)	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$		°C/W
Case Temperature 80°C, 100 W CW		0.49	
Case Temperature 80°C, 32 W CW		0.53	

- (1) MTTF calculator available at http://www.motorola.com/semiconductors/rf. Select Tools/Software/Application Software/Calculators to access the MTTF calculators by product.
- (2) Refer to AN1955/D, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to http://www.motorola.com/semiconductors/rf. Select Documentation/Application Notes AN1955.

NOTE - <u>CAUTION</u> - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.





ESD PROTECTION CHARACTERISTICS

Test Conditions	Class
Human Body Model	1 (Minimum)
Machine Model	M3 (Minimum)
Charge Device Model	C7 (Minimum)

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Zero Gate Voltage Drain Leakage Current (V _{DS} = 65 Vdc, V _{GS} = 0 Vdc)	I _{DSS}	_	_	10	μAdc
Zero Gate Voltage Drain Leakage Current $(V_{DS} = 28 \text{ Vdc}, V_{GS} = 0 \text{ Vdc})$	I _{DSS}	=	_	1	μAdc
Gate-Source Leakage Current (V _{GS} = 5 Vdc, V _{DS} = 0 Vdc)	I _{GSS}	_	_	1	μAdc
ON CHARACTERISTICS					

Gate Threshold Voltage (V _{DS} = 10 Vdc, I _D = 360 μAdc)	V _{GS(th)}	2.5	2.8	3.5	Vdc
Gate Quiescent Voltage (V _{DS} = 28 Vdc, I _D = 1400 mAdc)	V _{GS(Q)}	_	3.8	_	Vdc
Drain-Source On-Voltage (V _{GS} = 10 Vdc, I _D = 3.6 Adc)	V _{DS(on)}	_	0.24	_	Vdc
Forward Transconductance (V _{DS} = 10 Vdc, I _D = 3.6 Adc)	9 _{fs}	_	9		S

DYNAMIC CHARACTERISTICS

Reverse Transfer Capacitance (1)	C _{rss}	_	3.1	_	pF
$(V_{DS} = 28 \text{ Vdc}, V_{GS} = 0, f = 1 \text{ MHz})$					

FUNCTIONAL TESTS (In Motorola Test Fixture, 50 ohm system) 2-Carrier N-CDMA, 1.2288 MHz Channel Bandwidth Carriers. Peak/Avg = 9.8 dB @ 0.01% Probability on CCDF.

Common-Source Amplifier Power Gain (V_{DD} = 28 Vdc, P_{out} = 32 W Avg, I_{DQ} = 1400 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz)	G _{ps}	13	14	_	dB
Drain Efficiency $(V_{DD}=28\ Vdc,\ P_{out}=32\ W\ Avg,\ I_{DQ}=1400\ mA,\ f1=1930\ MHz,\ f2=1932.5\ MHz\ and\ f1=1987.5\ MHz,\ f2=1990\ MHz)$	η	24	26	_	%
Third Order Intermodulation Distortion (V _{DD} = 28 Vdc, P _{out} = 32 W Avg, I _{DQ} = 1400 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz; IM3 measured over 1.2288 MHz Bandwidth at f1 -2.5 MHz and f2 +2.5 MHz referenced to carrier channel power.)	IM3	_	-36.5	-35	dBc
Adjacent Channel Power Ratio (V _{DD} = 28 Vdc, P _{out} = 32 W Avg, I _{DQ} = 1400 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz; ACPR measured over 30 kHz Bandwidth at f1 -885 MHz and f2 +885 MHz)	ACPR	_	-50	-48	dBc
Input Return Loss $(V_{DD}=28\ Vdc,\ P_{out}=32\ W\ Avg,\ I_{DQ}=1400\ mA,\ f1=1930\ MHz,\ f2=1932.5\ MHz\ and\ f1=1987.5\ MHz,\ f2=1990\ MHz)$	IRL	_	-17	-9	dB

⁽¹⁾ Part is internally matched both on input and output.

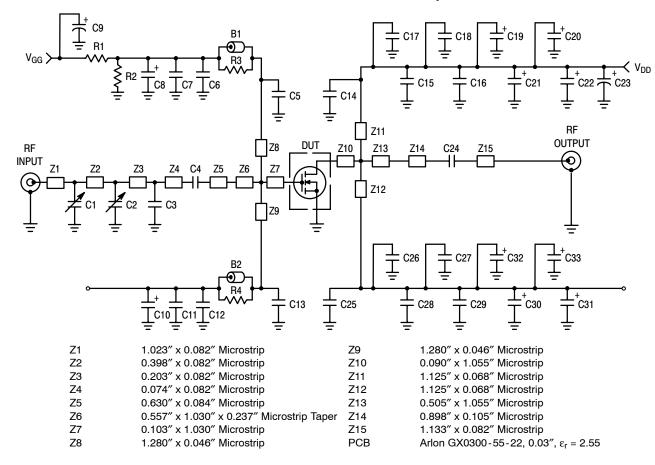


Figure 1. MRF5S19150 Test Circuit Schematic

Table 1. MRF5S19150 Test Circuit Component Designations and Values

	Part	Description		
B1, B2		Short RF Beads		
	C1, C2	0.6 – 4.5 Variable Capacitors, Gigatrim		
	C3	0.8 pF Chip Capacitor, B Case		
)	C4, C5, C13, C14, C24, C25	9.1 pF Chip Capacitors, B Case		
1	C8, C10	1.0 μF, 50 V SMT Tantalum Capacitors		
1	C6, C12, C16, C17, C18, C27, C28, C29	0.1 μF Chip Capacitors, B Case		
C7, C11, C15, C26 1000 pF Chip Capacitors, B Case		1000 pF Chip Capacitors, B Case		
C9 100 μF, 50 V Electrolytic Capacitor		100 μF, 50 V Electrolytic Capacitor		
	C23	470 μF, 63 V Electrolytic Capacitor		
C19, C20, C21, C22, C30, C31, C32, C33		22 μF, 35 V Tantalum Capacitors		
R1 1 kΩ Chip Resistor		1 kΩ Chip Resistor		
	R2	560 kΩ Chip Resistor		
R3, R4 12 Ω Chip Resistors				

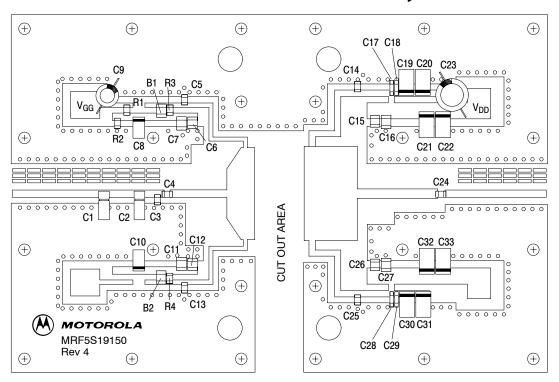


Figure 2. MRF5S19150 Test Circuit Component Layout

TYPICAL CHARACTERISTICS

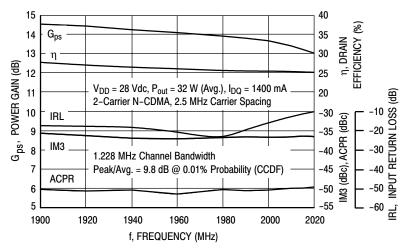


Figure 3. 2-Carrier N-CDMA Broadband Performance

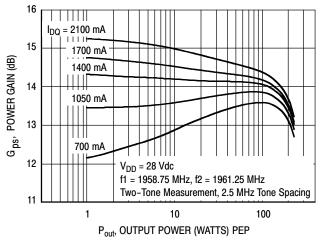


Figure 4. Two-Tone Power Gain versus
Output Power

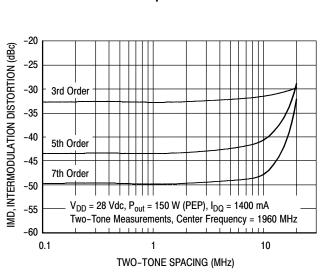


Figure 6. Intermodulation Distortion Products versus Tone Spacing

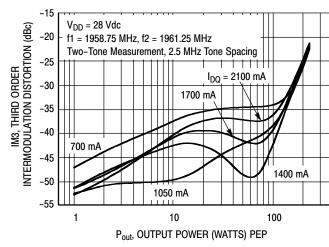


Figure 5. Third Order Intermodulation versus
Output Power

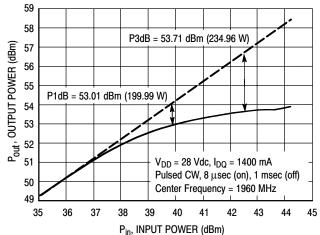


Figure 7. Pulse CW Output Power versus Input Power

TYPICAL CHARACTERISTICS

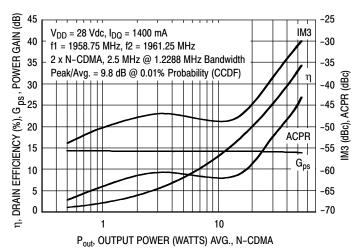


Figure 8. 2-Carrier N-CDMA ACPR, IM3, Power Gain, Drain Efficiency versus Output Power

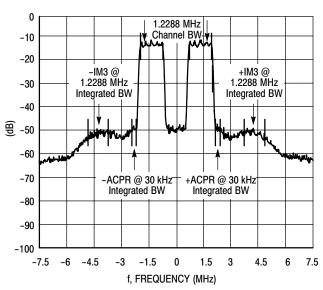
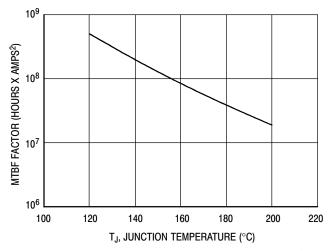
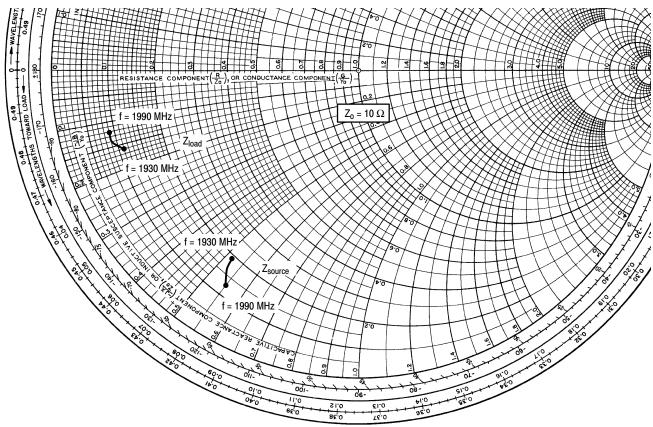


Figure 9. 2-Carrier N-CDMA Spectrum



This above graph displays calculated MTBF in hours x ampere 2 drain current. Life tests at elevated temperatures have correlated to better than $\pm 10\%$ of the theoretical prediction for metal failure. Divide MTBF factor by $I_D{}^2$ for MTBF in a particular application.

Figure 10. MTBF Factor versus Junction Temperature



 $V_{DD} = 28 \text{ V}, I_{DQ} = 1400 \text{ mA}, P_{out} = 32 \text{ W Avg}.$

f MHz	$oldsymbol{Z_{source}}_{\Omega}$	$oldsymbol{Z_{load}}{\Omega}$
1930	1.06 - j1.58	
1960	1.64 - j5.29	0.88 - j1.37
1990	1.3 - j5.49	0.90 - j1.21

Z_{source} = Test circuit impedance as measured from gate to ground.

Z_{load} = Test circuit impedance as measured from drain to ground.

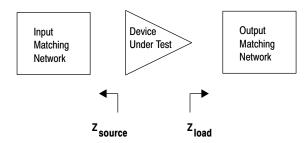
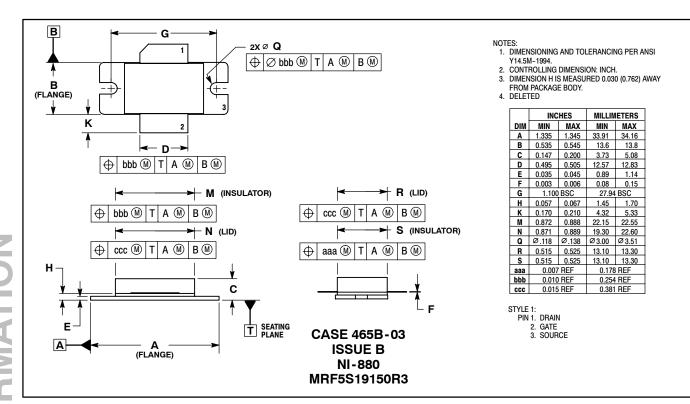
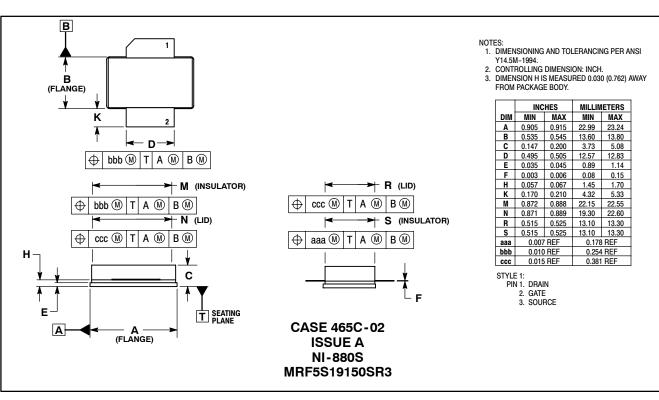


Figure 11. Series Equivalent Input and Output Impedance

PACKAGE DIMENSIONS





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